

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MH245FK

Octal Bus Transceiver

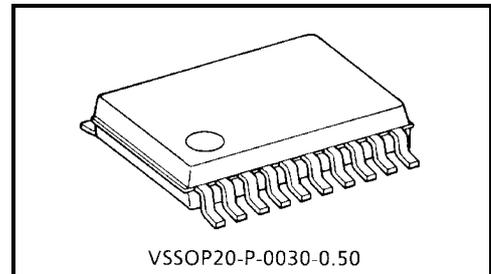
The TC7MH245FK is an advanced high speed CMOS octal bus transceiver fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

It is intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (\bar{G}) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.03 g (typ.)

Features

- High speed: $t_{pd} = 4.0 \text{ ns}$ (typ.) ($V_{CC} = 5 \text{ V}$)
- Low power dissipation: $I_{CC} = 4 \mu\text{A}$ (max) ($T_a = 25^\circ\text{C}$)
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: $V_{CC} (\text{opr}) = 2\sim 5.5 \text{ V}$
- Low noise: $V_{OLP} = 1.0 \text{ V}$ (max)
- Pin and function compatible with 74ALS245

Note: Do not apply a signal to any bus terminal when it is in the output mode. Damage may result.

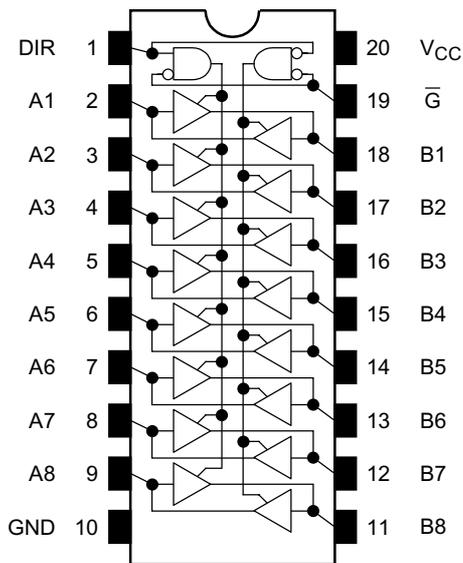
All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.

A parasitic diode is formed between the bus and V_{CC} terminals. Therefore bus terminal can not be used to interface 5 V to 3 V systems directly.

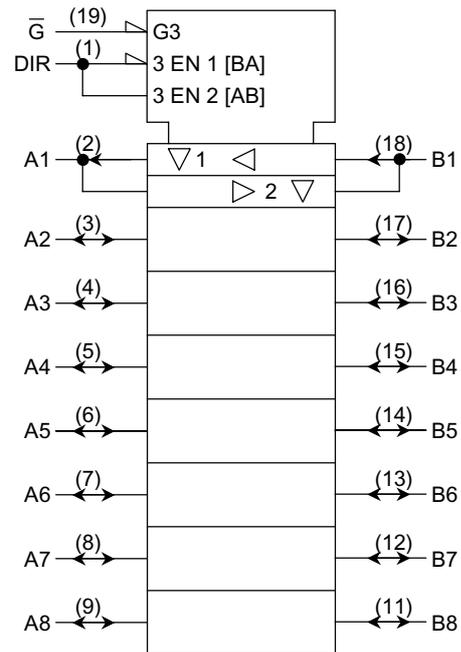
000630EBA1

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The Toshiba products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These Toshiba products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of Toshiba products listed in this document shall be made at the customer's own risk.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs		Outputs	Function	
\bar{G}	DIR		A-Bus	B-Bus
L	L	A = B	Output	Input
L	H	B = A	Input	Output
H	X	Z	Z	

X: Don't care

Z: High impedance

Maximum Ratings

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5~7.0	V
DC input voltage (DIR, \bar{G})	V_{IN}	-0.5~7.0	V
DC bus I/O voltage	$V_{I/O}$	-0.5~ $V_{CC} + 0.5$	V
Input diode current (DIR, \bar{G})	I_{IK}	-20	mA
Output diode current	I_{OK}	±20	mA
DC output current	I_{OUT}	±25	mA
DC V_{CC} /ground current	I_{CC}	±75	mA
Power dissipation	P_D	180	mW
Storage temperature	T_{stg}	-65~150	°C

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0~5.5	V
Input voltage (DIR, \overline{G})	V_{IN}	0~5.5	V
Bus I/O voltage	$V_{I/O}$	0~ V_{CC}	V
Operating temperature	T_{opr}	-40~85	°C
Input rise and fall time	dt/dv	0~100 ($V_{CC} = 3.3 \pm 0.3$ V) 0~20 ($V_{CC} = 5 \pm 0.5$ V)	ns/V

Electrical Characteristics

DC Characteristics

Characteristics		Symbol	Test Condition	$T_a = 25^\circ\text{C}$			$T_a = -40\sim 85^\circ\text{C}$		Unit		
				V_{CC} (V)	Min	Typ.	Max	Min		Max	
Input voltage	High level	V_{IH}	—	2.0 3.0~5.5	1.50 $V_{CC} \times 0.7$	— —	— —	1.50 $V_{CC} \times 0.7$	— —	V	
	Low level	V_{IL}	—	2.0 3.0~5.5	— —	— —	0.50 $V_{CC} \times 0.3$	— —	0.50 $V_{CC} \times 0.3$		
Output voltage	High level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50 \mu\text{A}$	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	— — —	1.9 2.9 4.4	— — —	V
				$I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$	3.0 4.5	2.58 3.94	— —	— —	2.48 3.80	— —	
					Low level	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50 \mu\text{A}$	2.0 3.0 4.5	— — —	
	$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$	3.0 4.5	— —	— —				0.36 0.36	— —	0.44 0.44	
		3-state output off-state current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND				5.5	—	—	
	Input leakage current	I_{IN}	$V_{IN} = 5.5 \text{ V}$ or GND	0~5.5	—	—	± 0.1	—	± 1.0	μA	
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	5.5	—	—	4.0	—	40.0	μA		

AC Characteristics (Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40~85°C		Unit			
			V _{CC} (V)	C _L (pF)	Min	Typ.	Max		Min	Max	
Propagation delay time	t_{pLH} t_{pHL}	—	3.3 ± 0.3	15	—	5.8	8.4	1.0	10.0	ns	
				50	—	8.3	11.9	1.0	13.5		
			5.0 ± 0.5	15	—	4.0	5.5	1.0	6.5		
				50	—	5.5	7.5	1.0	8.5		
3-state output enable time	t_{pZL} t_{pZH}	R _L = 1 kΩ	3.3 ± 0.3	15	—	8.5	13.2	1.0	15.5	ns	
				50	—	11.0	16.7	1.0	19.0		
			5.0 ± 0.5	15	—	5.8	8.5	1.0	10.0		
				50	—	7.3	10.6	1.0	12.0		
3-state output disable time	t_{pLZ} t_{pHZ}	R _L = 1 kΩ	3.3 ± 0.3	50	—	11.5	15.8	1.0	18.0	ns	
			5.0 ± 0.5	50	—	7.0	9.7	1.0	11.0		
Output to output skew	t_{osLH} t_{osHL}	(Note1)	3.3 ± 0.3	50	—	—	1.5	—	1.5	ns	
			5.0 ± 0.5	50	—	—	1.0	—	1.0		
Input capacitance	C _{IN}	DIR, \bar{G}				—	4	10	—	10	pF
Bus input capacitance	C _{I/O}	A _n , B _n				—	8	—	—	—	pF
Power dissipation capacitance	C _{PD}				(Note2)	—	21	—	—	—	pF

Note1: This parameter is guaranteed by design.

$$t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|$$

Note2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

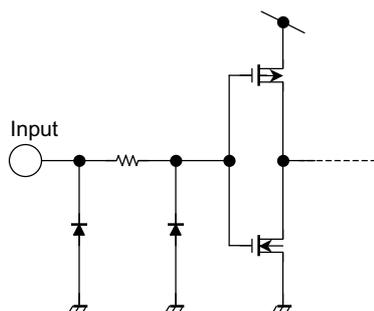
Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

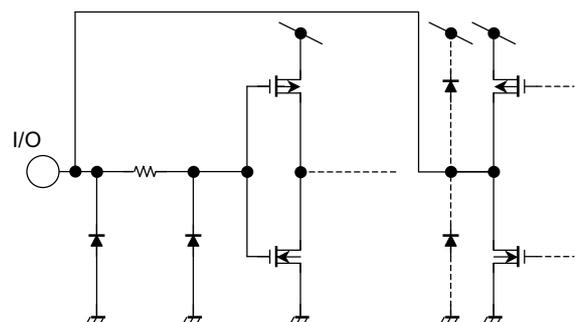
Noise Characteristics (Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C			Unit
			V _{CC} (V)	Typ.	Limit	
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.7	1.0	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.7	-1.0	V
Minimum high level dynamic input voltage V _{IH}	V _{IHD}	C _L = 50 pF	5.0	—	3.5	V
Maximum low level dynamic input voltage V _{IL}	V _{ILD}	C _L = 50 pF	5.0	—	1.5	V

Input Equivalent Circuit



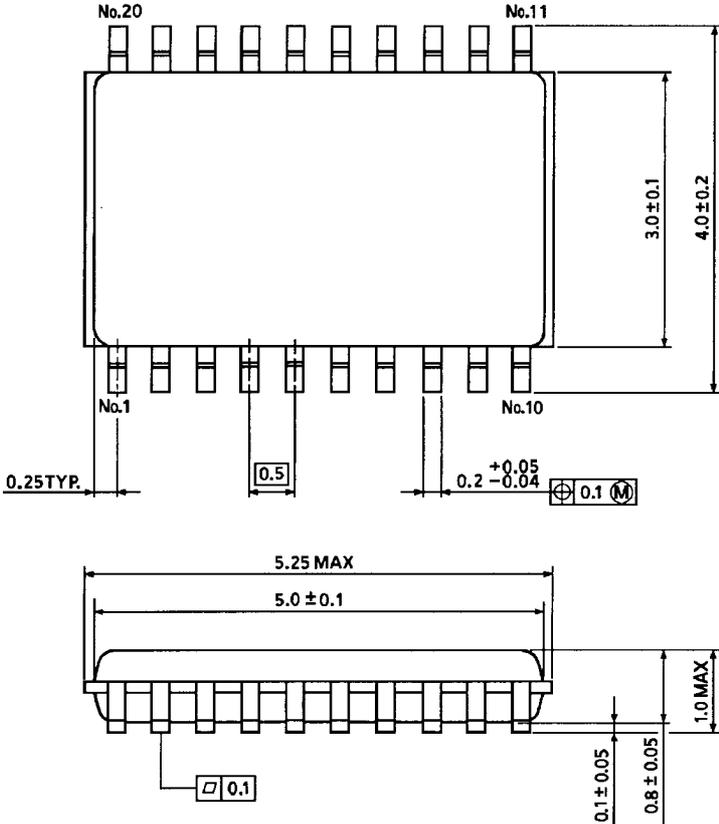
Bus Terminal Equivalent Circuit



Package Dimensions

VSSOP20-P-0030-0.50

Unit : mm



Weight: 0.03 g (typ.)